



Product End-of-Life Disassembly Instructions

Product Category: Networking Equipment

Marketing Name / Model

[List multiple models if applicable.]

HP 2920-24G Switch (J9726A)

HP 2920-48G Switch (J9728A)

Name / Model #3

Name / Model #4

Name / Model #5

Purpose: The document is intended for use by end-of-life recyclers or treatment facilities. It provides the basic instructions for the disassembly of HP products to remove components and materials requiring selective treatment, as defined by EU directive 2002/96/EC, Waste Electrical and Electronic Equipment (WEEE).

1.0 Items Requiring Selective Treatment

1.1 Items listed below are classified as requiring selective treatment.

1.2 Enter the quantity of items contained within the product which require selective treatment in the right column, as applicable.

Item Description	Notes	Quantity of items included in product
Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA)	With a surface greater than 10 sq cm 2 in product, 1 in power supply	3
Batteries	All types including standard alkaline and lithium coin or button style batteries	0
Mercury-containing components	For example, mercury in lamps, display backlights, scanner lamps, switches, batteries	0
Liquid Crystal Displays (LCD) with a surface greater than 100 sq cm	Includes background illuminated displays with gas discharge lamps	0
Cathode Ray Tubes (CRT)		0
Capacitors / condensers (Containing PCB/PCT)		0
Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height	2 in power supply	2
External electrical cables and cords	Power cord and Console RJ45 cable	2
Gas Discharge Lamps		0
Plastics containing Brominated Flame Retardants weighing > 25 grams (not including PCBs or PCAs already listed as a separate item above)		0
Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner	Include the cartridges, print heads, tubes, vent chambers, and service stations.	0
Components and waste containing asbestos		0
Components, parts and materials containing refractory ceramic fibers		0

Components, parts and materials containing radioactive substances		0
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2.0 Tools Required

List the type and size of the tools that would typically be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

Tool Description	Tool Size (if applicable)
Torx Driver (Standard)	T10 and T15
Small Adjustable wrench	5mm
Wire Cutter	Medium
Description #4	
Description #5	

3.0 Product Disassembly Process

3.1 List the basic steps that should typically be followed to remove components and materials requiring selective treatment:

1. Unscrew and remove -SCREW-MACHINE #6-32mm T10
2. Unscrew and remove ASSY BULKHEAD BLANK RL GL
3. Unscrew and remove ASSY BULKHEAD BLANK STACK
4. Unscrew and remove ASSY, XPS COVER
5. Remove PWR-SPLY POWER-165W SINGLE-OUT 12V 12.5A
6. Remove ASSY CHASSIS TOP COVER NON-POE
7. Unscrew and remove PCA, XPS CARD (E2920)
8. Unscrew and remove ASSY, FAN TRAY
9. Remove CABLE, INTERNAL XPS LOAD
10. Remove CABLE, INTERNAL XPS SIGNAL
11. Unscrew and remove ASSY, LED CARD & MECH
12. Remove COVER DUST SFP ROHS
13. Remove LIGHTPIPE, 1U WITH RJ-ROHS
14. Unscrew and remove ASSY, 24P NON-POE PCA & MECH (MILOS PCA 5066-1420)
15. Unscrew and remove CONNECTOR SHIELD, XPS
16. Remove ASSEMBLY, FRONT FLAP
17. Remove INSULATOR SHEET, BOTTOM
- 18.
- 19.

3.2 Optional Graphic. If the disassembly process is complex, insert a graphic illustration below to identify the items contained in the product that require selective treatment (with descriptions and arrows identifying locations).



